



Product Change Notification

Change Notification #: 118759-00
Change Title: Intel® SSD DC P4511 Series M.2 SKUs
PCN 118759-00, Product Material,
Adding new ICs as 2nd Source Components
Date of Publication: December 08, 2021

Key Characteristics of the Change:

Product Material

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material	February 09, 2022
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Description of Change to the Customer:

The Intel SKUs listed in the products affected table will have the following changes.

- All SKUs adding the following alternate components:

Component Type	Use Case	Current Component(s)	Alternate Component(s)	Affected MM#s
MOSFET	Vcap Switch	Diodes, Inc. (J53658-001)	Toshiba (M59118-001) Infineon (J88109-001)	965843, 965844
MOSFET	SMBus LVL Shifter	Nexperia (H75826-001)	Diodes, Inc. (K41819-001)	
MOSFET	Input FET	Texas Instruments (J37842-001)	Infineon (G85273-001)	
Circuit Protection Diode	3.3V Aux	Diodes, Inc./ON Semi (G24376-001)	Nexperia (M59419-001)	
Voltage Regulator	N/A	Texas Instruments (G88411-001)	ON Semi (G88411-002)	

Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers.

Please contact your local Intel Field Sales Representative if you have any further questions about these changes.

Products Affected/Intel Ordering Codes:

Marketing Name	Product Code	MM#
Intel® SSD DC P4511 Series (1.0TB, M.2 110mm PCIe 3.1 x4, 3D2, TLC) Generic Single Pack	SSDPELKX010T801	965843
Intel® SSD DC P4511 Series (2.0TB, M.2 110mm PCIe 3.1 x4, 3D2, TLC) Generic Single Pack	SSDPELKX020T801	965844

PCN Revision History:

Date of Revision:

December 08, 2021

Revision Number:

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Reason:

Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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